

**SPECIFICATION
FOR
LCM+CTP Module**

MODULE No:	KD035QHFID161-C062B
CUSTOMER:	

STARTEK	INITIAL	DATE
PREPARED BY		
CHECKED BY		
APPROVED BY		

CUSTOMER	INITIAL	DATE
APPROVED BY		

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1. Basic Specifications

* Description

This is a color active matrix TFT (Thin Film Transistor) LCD (liquid crystal display) that uses amorphous silicon TFT as a switching device. This module is composed of a Transmissive type TFT-LCD Panel, driver circuit, capacitance touch panel, back-light unit. The resolution of a 3.54 " TFT-LCD contains 640x960 pixels, and can display up to 16.7M colors.

1.1 TFT Features

General Information Items	Specification	Unit	Note
	Main Panel		
Display area(AA)	49.92(H)*74.88(V) (3.54 inch)	mm	
Driver element	TFT active matrix	-	
Display colors	65K/262K/16.7M	colors	
Number of pixels	640(RGB)*960	dots	
Pixel arrangement	RGB vertical stripe	-	
Pixel pitch	0.078(H)*0.078(V)	mm	
Viewing angle	Free	o'clock	
Controller IC	ST7703	-	
Display mode	Transmissive /Normally Black	-	
LCM Interface	1/2/3/4Lane MIPI	-	
Operating temperature	-30~+85	°C	
Storage temperature	-30~+85	°C	
Module bonding technology	Use OCA bonding between LCM and CTP	-	

1.2 CTP Features

General Information Items	Specification	Unit	Note
	Main Panel		
Resolution	640(H)*960(V)	-	
Structure	G+G	-	
Controller IC	GT911	-	
Interface	I2C	-	
Slave Address	0x5D(7bit) or 0x14(7bit)	-	Note1
Touch mode	Five points and Gestures	-	-
Logic level	3.3	V	

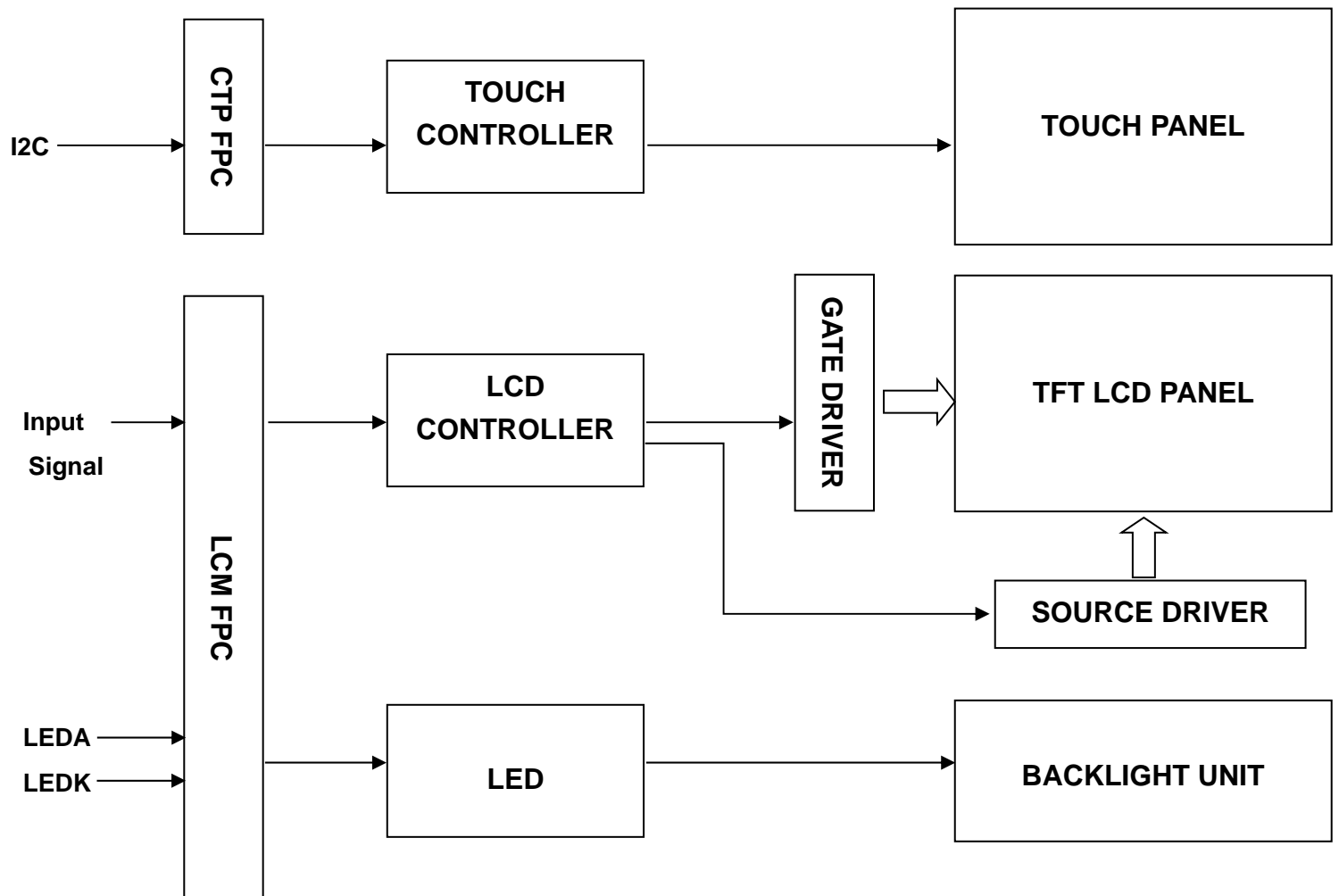
Note1: For specific configuration method, please refer to section 8.2

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1.3 Mechanical Information

Item		Min.	Typ.	Max.	Unit	Note
Module size	Horizontal(H)	-	61.90	-	mm	
	Vertical(V)	-	96.04	-	mm	
	Depth(D)	-	4.57	-	mm	
Weight		-	TBD	-	g	

2. Block Diagram



4. Input terminal Pin Assignment

4.1 TFT PIN Define

NO.	SYMBOL	DISCRIPTION	I/O
1	NC	--	--
2	LEDK	Cathode pin of backlight.	P
3	NC	--	--
4	LEDA	Anode pin of backlight.	P
5	NC	--	--
6	GND	Ground.	P
7	MIPI_D0N	- MIPI DSI differential data pair. (Data lane 0)	I
8	MIPI_D0P		I
9	GND	Ground.	P
10	MIPI_D1N	- MIPI DSI differential data pair. (Data lane 1)	I
11	MIPI_D1P		I
12	GND	Ground.	P
13	MIPI_CLN	- MIPI DSI differential clock pair	I
14	MIPI_CLP		I
15	GND	Ground.	P
16	MIPI_D2N	- MIPI DSI differential data pair. (Data lane 2)	I
17	MIPI_D2P	Leave it o to GND level when not in use.	I
18	GND	Ground.	P
19	MIPI_D3N	- MIPI DSI differential data pair. (Data lane 3)	I
20	MIPI_D3P	Leave it to GND level when not in use.	I
21	GND	Ground.	P
22	GND	Ground.	P
23	NC	--	--

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24	GND	Ground.	P
25	TE	- Tearing effect output pin. Leave the pin open when not in use.	O
26	RESET	- The external reset input Initializes the chip with a low input. Be sure to execute a power-on reset aftersupplying power.	I
27	IOVCC	I/O power supply voltage.	P
28	VCI	Supply Voltage .	P
29	GND	Ground.	P
30	GND	Ground.	P

4.2 CTP PIN Define

NO.	SYMBOL	DISCRIPTION	I/O
1	GND	Ground.	P
2	NC		
3	VDD	Supply voltage.	P
4	SCL	I2C clock input.	I
5	SDA	I2C data input and output	I/O
6	INT	External interrupt to the host.	I
7	RST	External Reset, Low is active.	I
8	GND	Ground.	P

5. LCD Optical Characteristics

5.1 Optical specification

Item	Symbol	Condition	Min.	Typ.	Max.	Unit.	Note
Contrast Ratio	CR	$\Theta=0$	800	1000	--		(1)(2)
Response time	Rising	T_{R+T_F}	--	35	40	msec	(1)(3)
	Falling						
Color Gamut	S(%)		65	70	--	%	
Color Filter Chromaticity	White	W_X	0.2440	0.2840	0.3240		(1)(4) s
		W_Y	0.2830	0.3230	0.3630		
	Red	R_X	0.5935	0.6335	0.6735		
		R_Y	0.3035	0.3435	0.3835		
	Green	G_X	0.2550	0.2950	0.3350		
		G_Y	0.5345	0.5745	0.6145		
	Blue	B_X	0.1045	0.1445	0.1845		
		B_Y	0.0273	0.0673	0.1073		
Viewing angle	Hor.	Θ_L	--	85	--		(1)(4)
		Θ_R	--	85	--		
	Ver.	Θ_U	--	85	--		
		Θ_D	--	85	--		
Option View Direction	Free						

Measuring Condition

Measuring surrounding : dark room

Ambient temperature : $25\pm 2^\circ\text{C}$

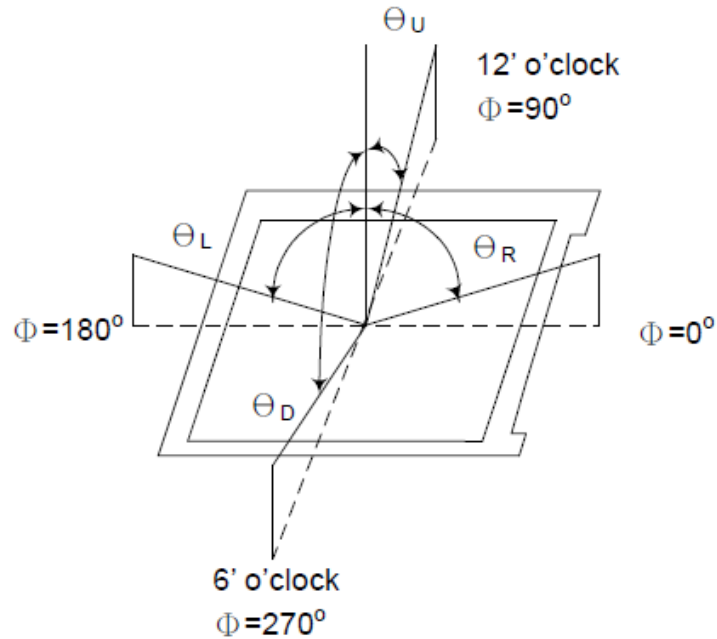
15min. warm-up time.

Measuring Equipment

FPM520 of Westar Display technologies, INC., which utilized SR-3 for Chromaticity and BM-5A for other optical characteristics.

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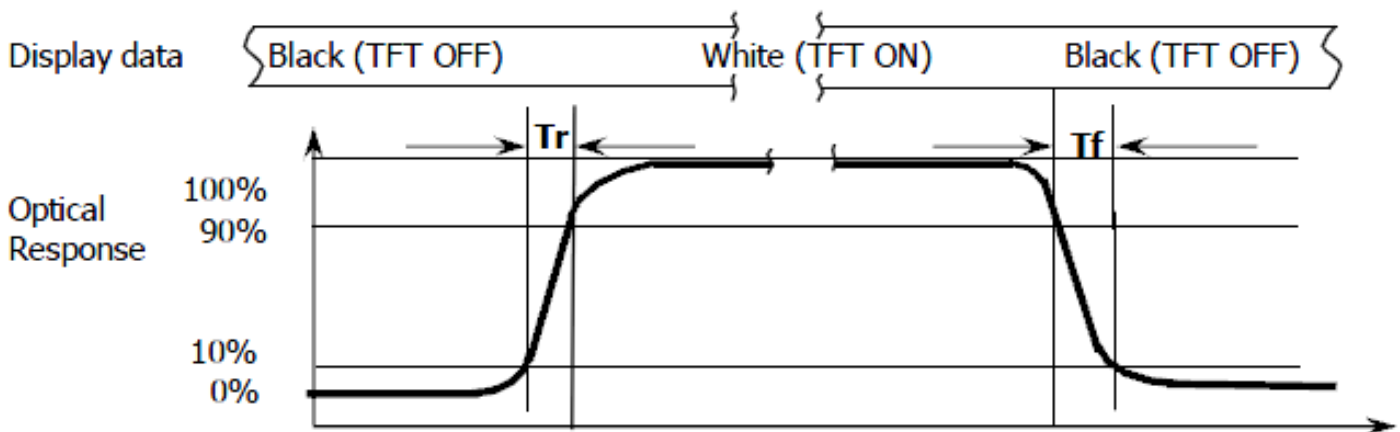
Note (1): Definition of Viewing Angle :



Note (2): Definition of Contrast Ratio(CR) :measured at the center point of panel

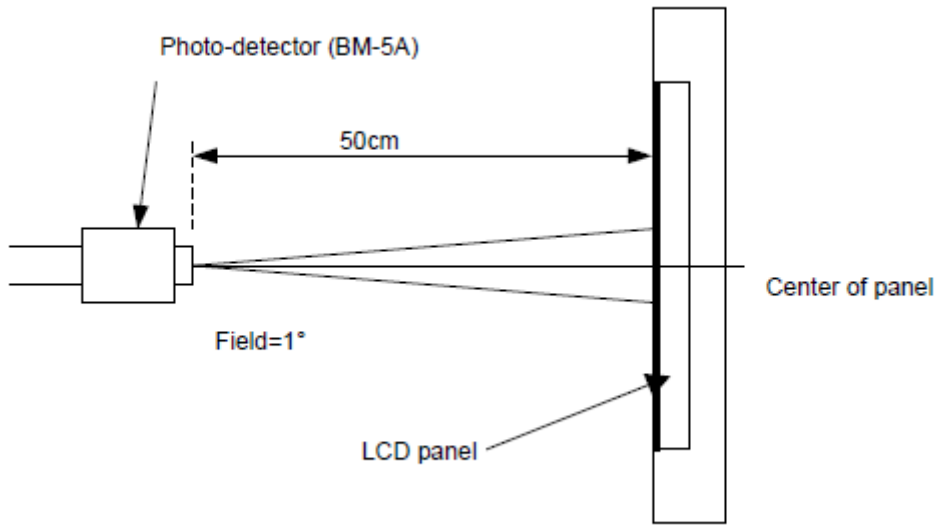
$$CR = \frac{\text{Luminance with all pixels white}}{\text{Luminance with all pixels black}}$$

Note (3): Response Time



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Note (4): Definition of optical measurement setup



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6. Electrical Characteristics

6.1 Absolute Maximum Rating

Characteristics	Symbol	Min.	Max.	Unit	Note
Digital Supply Voltage	V _{CI}	-0.3	6.6	V	Note1
Digital interface supply Voltage	IOVCC	-0.3	4.5	V	Note1
Operating temperature	T _{OP}	-30	+85	°C	
Storage temperature	T _{ST}	-30	+85	°C	

NOTE1: If the absolute maximum rating of even is one of the above parameters is exceeded even momentarily, the quality of the product may be degraded. Absolute maximum ratings, therefore, specify the values exceeding which the product may be physically damaged. Be sure to use the product within the range of the absolute maximum ratings.

6.2 DC Electrical Characteristics

Characteristics	Symbol	Min.	Typ.	Max.	Unit	Note
Digital Supply Voltage	V _{CI}	2.5	3.3	3.6	V	
Digital interface supply Voltage	IOVCC	1.65	1.8	3.6	V	
Normal mode Current	I _{VCI}	--	50	60	mA	
Level input voltage	V _{IH}	0.7*IOVCC	--	IOVCC+0.3	V	
	V _{IL}	GND-0.3	--	0.3*IOVCC	V	
Level output voltage	V _{OH}	IOVCC-0.4	--	--	V	
	V _{OL}	GND	--	GND+0.4	V	

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常备库存 Stock For Sale	长期供货 Long Time supply	支持小量 NO MOQ	品种齐全 In Full Range	

6.3 LED Backlight Characteristics

The back-light system is edge-lighting type with 10 chips LED

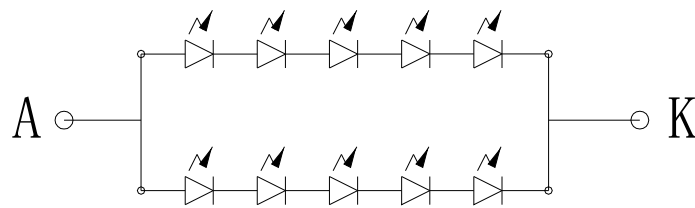
Item	Symbol	Min.	Typ.	Max.	Unit	Note
Forward Current	I_F	35	40	--	mA	
Forward Voltage	V_F	--	15	--	V	
LCM Luminance	LV	400	450	--	cd/m ²	Note3
LED life time	Hr	--	50000	--	Hour	Note1,2
Uniformity	Avg	80	--	--	%	Note3

Note1: LED life time (Hr) can be defined as the time in which it continues to operate under the condition:

$T_a=25\pm3$ °C, typical IL value indicated in the above table until the brightness becomes less than 50%.

Note 2: The “LED life time” is defined as the module brightness decrease to 50% original brightness at

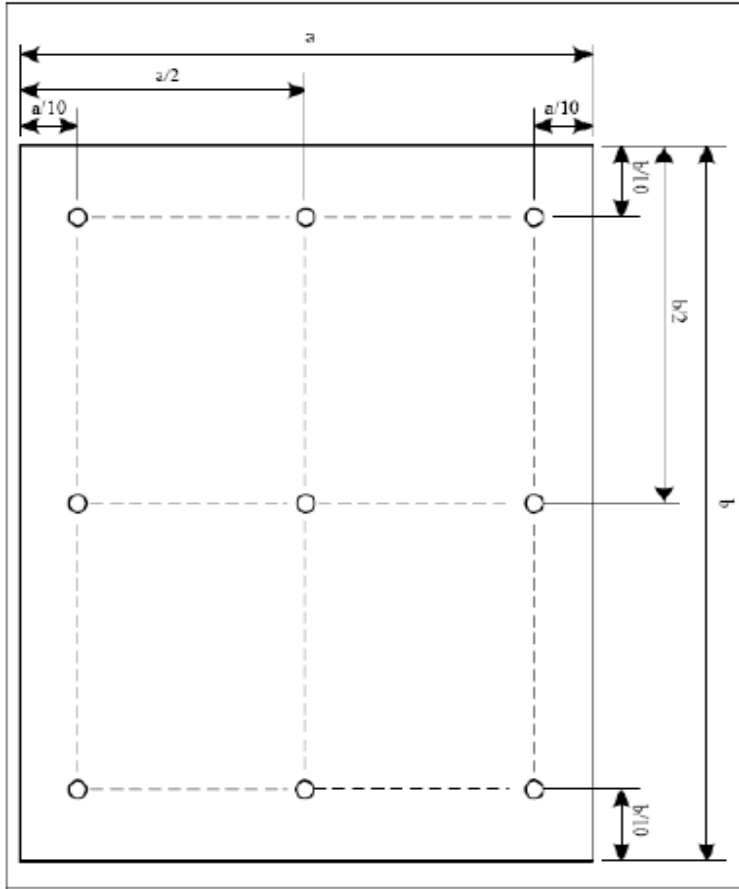
$T_a=25$ °C and $I_L=40$ mA. The LED lifetime could be decreased if operating I_L is larger than 40mA. The constant current driving method is suggested.



LED (B/L) CIRCUIT

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Note (3) Luminance Uniformity of these 9 points is defined as below:



$$\text{Uniformity} = \frac{\text{minimum luminance in 9 points (1-9)}}{\text{maximum luminance in 9 points (1-9)}}$$

$$\text{Luminance} = \frac{\text{Total Luminance of 9 points}}{9}$$

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6.4 DSI DC Characteristics

LP Mode

Parameter	Symbol	Conditions	Spec.			Unit
			Min.	Typ.	Max.	
Logic high level input voltage	V_{IHLPCD}	LP-CD	450	-	1350	mV
Logic low level input voltage	V_{ILLPCD}	LP-CD	0	-	200	mV
Logic high level input voltage	V_{IHLPRX}	LP-RX(CLK, D0)	880	-	1350	mV
Logic low level input voltage	V_{ILLPRX}	LP-RX(CLK, D0)	0	-	550	mV
Logic low level input voltage	$V_{ILLPRXULP}$	LP-RX(CLK ULP mode)	0	-	300	mV
Logic high level output voltage	V_{OHLPTX}	LP-TX(D0)	1.1	-	1.3	V
Logic low level output voltage	V_{OLLPTX}	LP-TX(D0)	-50	-	50	mV
Logic high level input current	V_{IH}	LP-CD, LP-RX	-	-	10	μ A
Logic low level input current	V_{IL}	LP-CD, LP-RX	-10	-	-	μ A
Input pulse rejection	SGD	DSI-CLK+/-, DSI-D0+/-1	-	-	300	Vps



*Input glitch rejections of low-power receivers

High Speed Mode

Parameter	Symbol	Conditions	Spec.			Unit
			Min.	Typ.	Max.	
Input common mode	V_{CMCLK} V_{CMDATA}	DSI_CP/DSI_CN DSI_D0P/DSI_D0P	70	-	330	mV
Input common mode variation <450 MHz	$V_{CMRCLKL}$ $V_{CMRDATAL}$	DSI_CP/DSI_CN DSI_D0P/DSI_D0P	-50	-	50	mV
Input common mode variation >450 MHz	$V_{CMRCLKM}$ $V_{CMRDATAM}$	DSI_CP/DSI_CN DSI_D0P/DSI_D0P	-	-	100	mV
Low-level differential Input threshold	V_{THLCLK} $V_{THLDATA}$	DSI_CP/DSI_CN DSI_D0P/DSI_D0P	-70	-	-	mV
High-level differential Input threshold	V_{THHCLK} $V_{THHDATA}$	DSI_CP/DSI_CN DSI_D0P/DSI_D0P	-	-	70	mV
Single ended input low voltage	V_{ILHS}	DSI_CP/DSI_CN DSI_D0P/DSI_D0P	-40	-	-	mV
Single ended input high voltage	V_{IHHS}	DSI_CP/DSI_CN DSI_D0P/DSI_D0P	-	-	460	mV
Differential input termination resistor	R_{TERM}	DSI_CP/DSI_CN DSI_D0P/DSI_D0P	80	100	125	Ω
Single-ended threshold voltage for termination enable	V_{TERMEN}	DSI_CP/DSI_CN DSI_D0P/DSI_D0P	-	-	450	mV
Termination capacitor	C_{TERM}	DSI_CP/DSI_CN DSI_D0P/DSI_D0P	-	-	-	pF

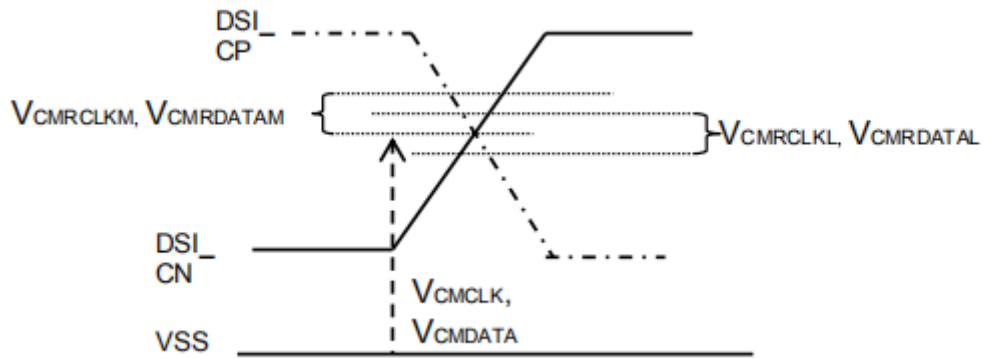
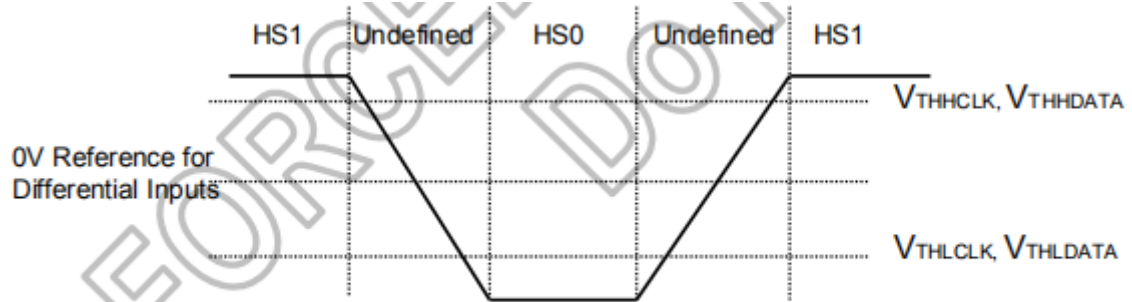
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常备库存
Stock For Sale

长期供货
Long Time supply

支持小量
NO MOQ

品种齐全
In Full Range



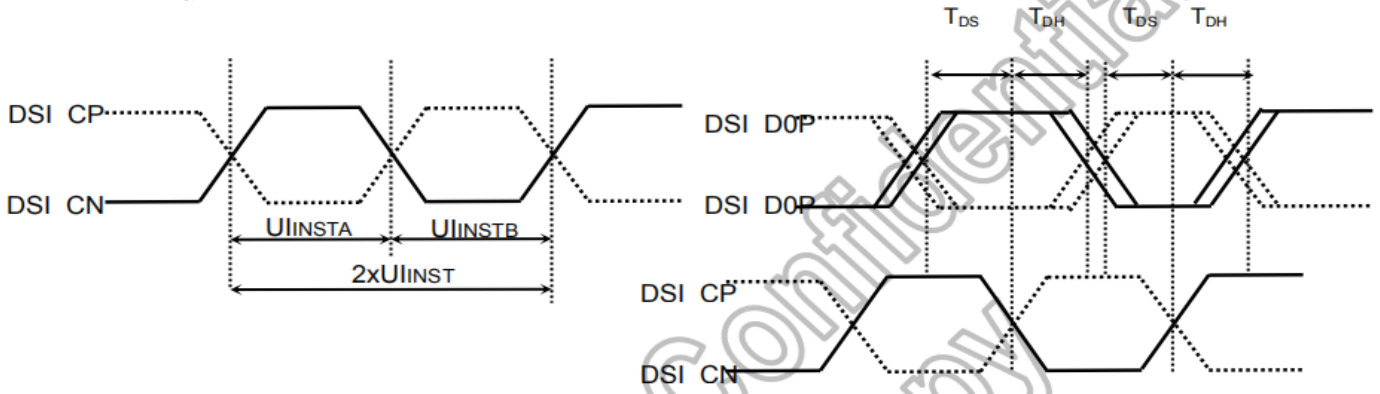
***Differential voltage range and Command mode voltage**

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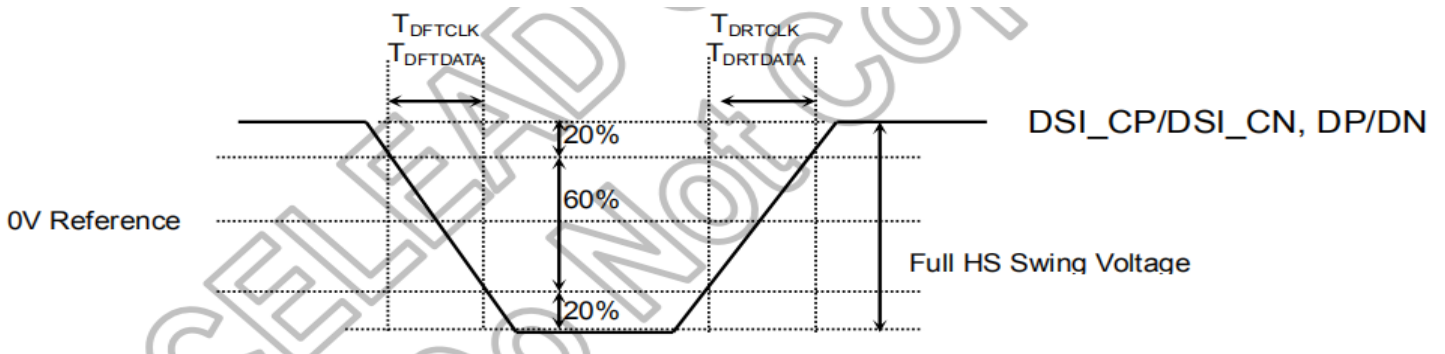
7. AC Characteristic

7.1 DSI Interface Timing Characteristics:

7.1.1 High Speed Mode



***DSI clock timing Characteristics**



***Rising and falling time on clock and data channel**

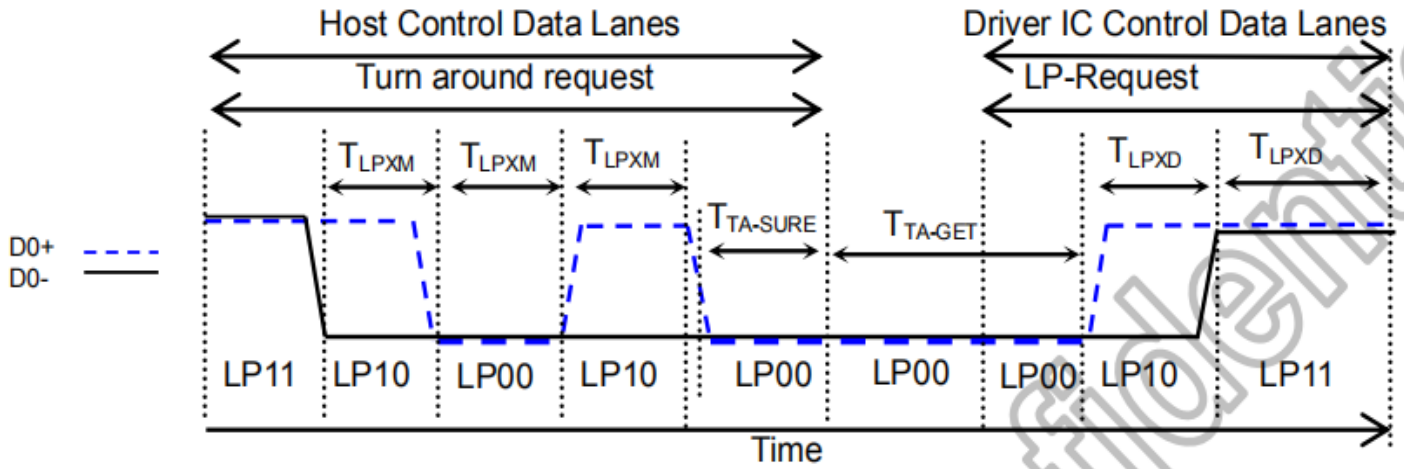
(VSSA=0V, IOVCC=1.65V to 3.3V, VCI=2.5V to 3.3V, $T_A = -30$ to 70°C)

Signal	Item	Symbol	Spec.			Unit
			Min.	Typ.	Max.	
DSI_CP/ DSI_CN	Double UI instantaneous	$2xU_{INST}$	TBD	-	25	ns
	UI instantaneous	U_{INSTA} U_{INSTB}	TBD	-	12.5	ns
DP/DN	Data to clock setup time	T_{DS}	$0.15xUI$	-	-	ps
	Data to clock hold time	T_{DH}	$0.15xUI$	-	-	ps
DSI_CP/ DSI_CN	Differential rise time for clock	T_{DRTCLK}	150	-	$0.3UI$	ps
	Differential fall time for clock	T_{DFTCLK}	150	-	$0.3UI$	ps
DP/DN	Differential rise time for data	$T_{DRTDATA}$	150	-	$0.3UI$	ps
	Differential fall time for data	$T_{DFTDATA}$	150	-	$0.3UI$	ps

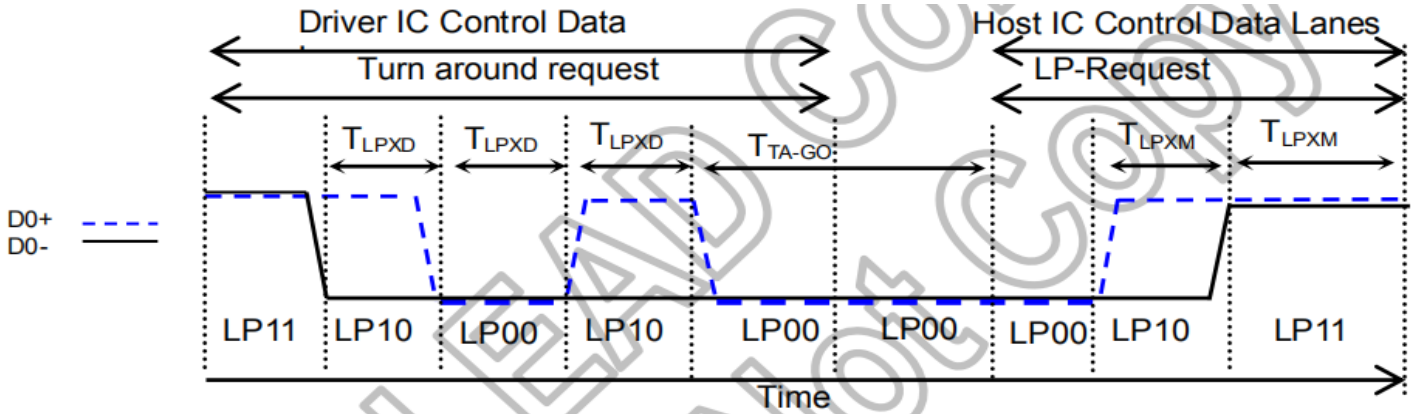
***DSI High Speed Mode Characteristics**

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7.1.2 Low Power Mode



***BTA from HOST to Display Module Timing**



***BTA from Display Module Timing to HOST**

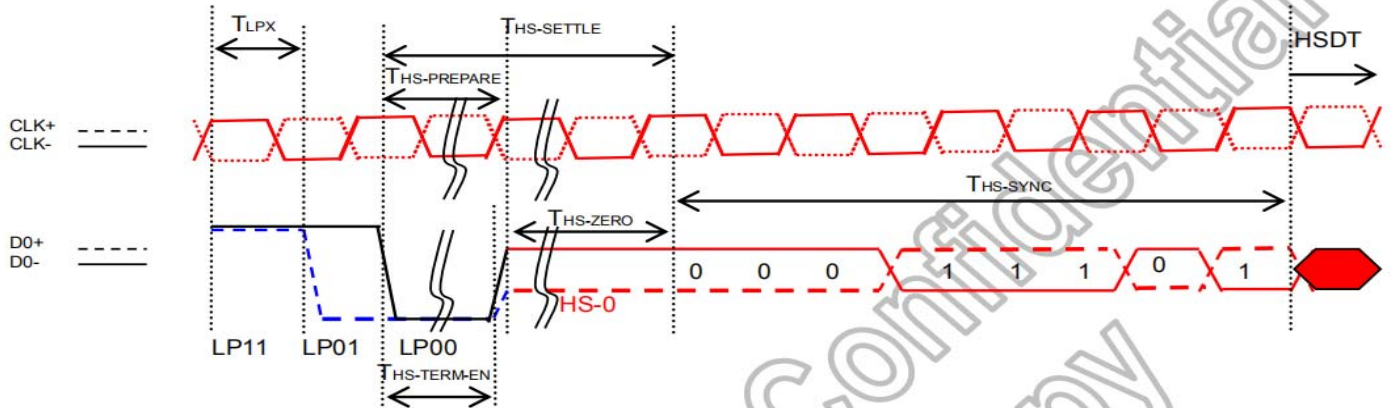
(VSSA=0V, IOVCC=1.65V to 3.3V, VCI=2.3V to 3.3V, TA = -30 to 70°C)

Signal	Item	Symbol	Spec.			Unit
			Min.	Typ.	Max.	
DSI_D0P/ DSI_D0P	Length of LP-00/LP01/LP10/LP11 Host → Display module	T _{LPXM}	50	-	-	ns
	Length of LP-00/LP01/LP10/LP11 Display module → Host	T _{LPXD}	50	-	-	ns
	Time-out before the MPU start driver	T _{TA-SURE}	T _{LPXD}	-	2xT _{LPXD}	ns
	Time to drive LP-00 by display module	T _{TA-GET}	5xT _{LPXD}	-	-	ns
	Time to drive LP-00 after turnaround request Host	T _{TAGO}	4xT _{LPXD}	-	-	ns

***DSI Low Power Mode Characteristics**

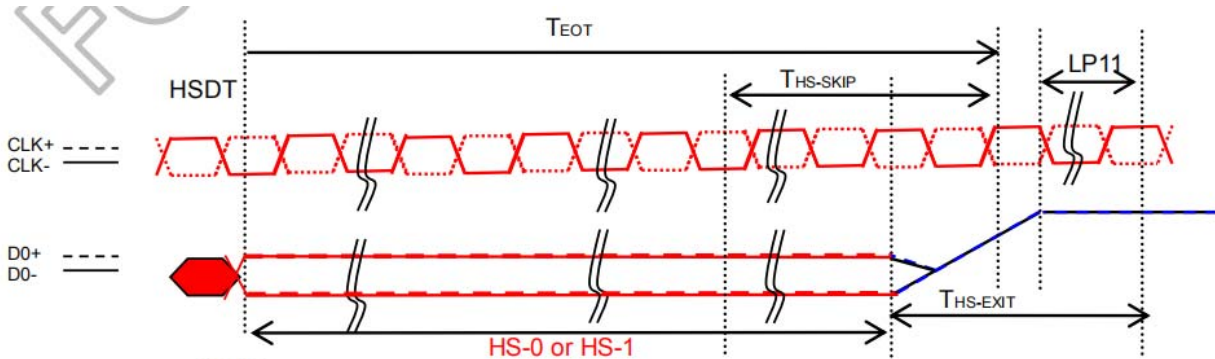
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7.1.3 Bursts Mode



Signal	Item	Symbol	Spec.			Unit
			Min.	Typ.	Max.	
DSI_D0P/ DSI_D0P	Length of LP-00/LP01/LP10/LP11	T _{LPX}	50	-	-	ns
	Time to Driver LP-00 to prepare for HS transmission	T _{HS-PREPARE}	40+4UI	-	85+6UI	ns
	Time to enable data receiver line termination	T _{HS-TERM-EN}	-	-	35+4xUI	ns
	Time to drive LP-00 by display module	T _{TA-GET}	5xT _{LPXD}	-	-	ns
	Time to drive LP-00 after turnaround request Host	T _{TAGO}	4xT _{LPXD}	-	-	ns

*DSI Low Power Mode to High Speed Mode Timing

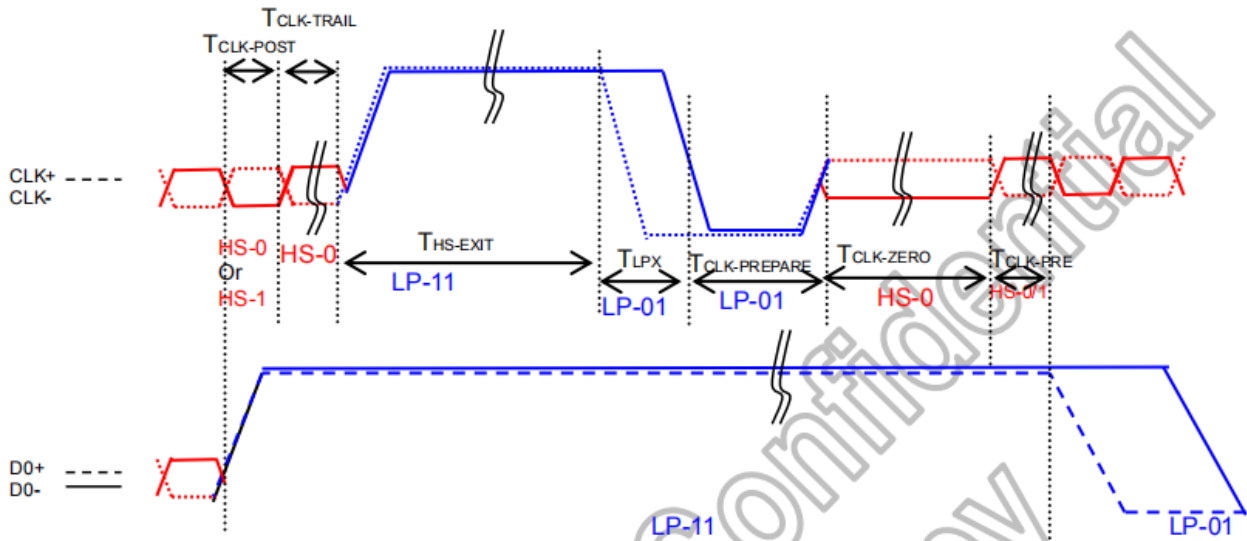


NOTE:
 If the last bit is HS-0, the transmitter changes from HS-0 to HS-1
 If the last bit is HS-1, the transmitter changes from HS-1 to HS-0

Signal	Item	Symbol	Spec.			Unit
			Min.	Typ.	Max.	
DSI_D0P/ DSI_D0P	Time-Out at Display Module to Ignore Transition Period of EoT	T _{HS-SKIP}	40	-	55+4xUI	ns
	Time to Driver LP-11 after HS Burst	T _{HS-EXIT}	100	-	-	ns

*DSI Low Power Mode to High Speed Mode Timing

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Signal	Item	Symbol	Spec.			Unit
			Min.	Typ.	Max.	
DSI_CP/ DSI_CN	Time that the MCU shall continue sending HS clock after the last associated Data Lane has transitioned to LP mode	$T_{CLK-POST}$	$60+52xUI$	-	-	ns
	Time to drive HS differential state after last payload clock bit of a HS transmission burst	$T_{CLK-TRAIL}$	60	-	-	ns
	Time to drive LP-11 after HS burst	$T_{HS-EXIT}$	100	-	-	ns
	Time to drive LP-00 to prepare for HS transmission	$T_{CLK-PREPARE}$	38	-	95	ns
	Time-out at Clock Lane Display Module to enable HS Termination	$T_{CLK-TERM-EN}$	-	-	38	ns
	Minimum lead HS-0 drive period before starting Clock	$T_{CLK-PREPARE} + T_{CLK-ZERO}$	300	-	-	ns
	Time that the HS clock shall be driven prior to any associated data Lane beginning the transition from LP to HS mode	$T_{CLK-PRE}$	$8xUI$			

***Clock Lanes High Speed Mode to/from Low Power Mode Timing**

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7.2 Reset timing

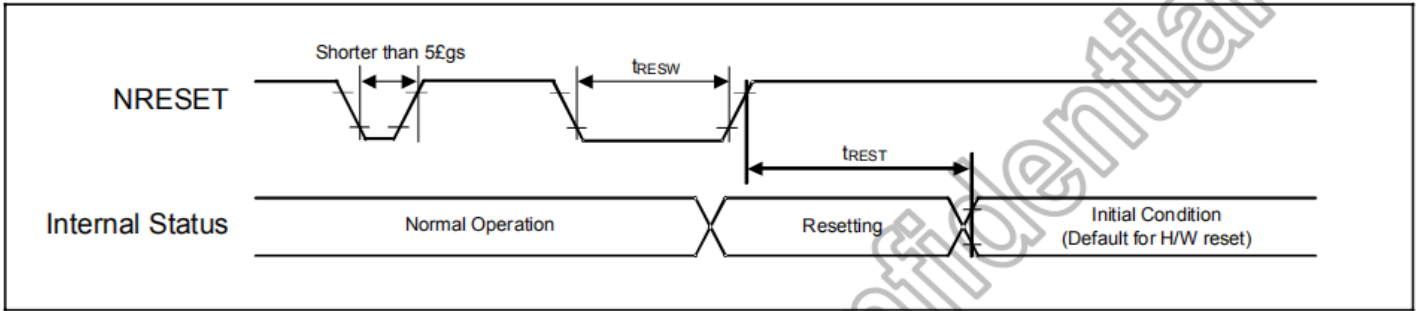


Figure 7.8: Reset input timing

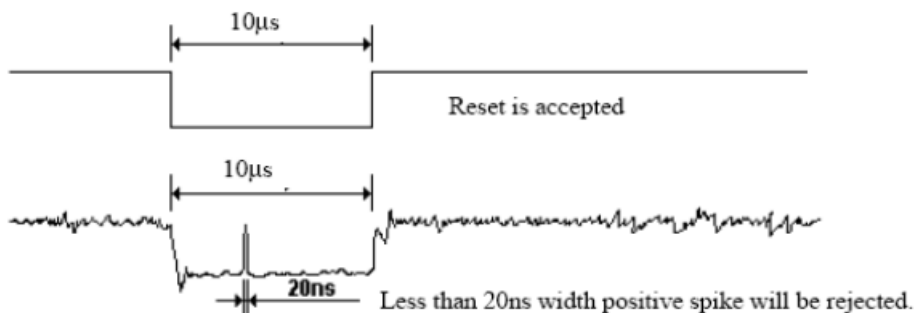
Symbol	Parameter	Related Pins	Spec.			Note	Unit
			Min.	Typ.	Max.		
tRESW	Reset low pulse width ⁽¹⁾	NRESET	10	-	-	-	μs
tREST	Reset complete time ⁽²⁾	-	15	-	-	When reset applied during SLPIN mode	ms
		-	120	-	-	When reset applied during SLPOUT mode	ms

Table 7.8: Reset Input Timing

Note: (1) Spike due to an electrostatic discharge on NRESET line does not cause irregular system reset according to the following table.

NRESET Pulse	Action
Shorter than 5 μs	Reset Rejected
Longer than 10 μs	Reset
Between 5 μs and 10 μs	Reset Start

- (2) During the resetting period, the display will be blanked (The display is entering blanking sequence, which Maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode) and then return to Default condition for H/W reset.
- (3) During Reset Complete Time, ID and VCOM value in OTP will be latched to internal register during this period. This loading is done every time when there is H/W reset complete time (tREST) within 15ms after a rising edge of NRESET.
- (4) Spike Rejection also applies during a valid reset pulse as shown as below:



- (5) It is necessary to wait 15msec after releasing NRESET before sending commands. Also Sleep Out command cannot be sent for 120msec.

Part. No	KD035QHFID161-C062B	REV	V1.0	Page 21 of 38
常备库存 Stock For Sale	长期供货 Long Time supply	支持小量 NO MOQ	品种齐全 In Full Range	

8. CTP Specification

8.1 Electrical Characteristics

8.1.1 Absolute Maximum Rating

Item	Symbol	Min.	Max.	Unit	Note
Power Supply Voltage	VDD	2.66	3.47	V	
Operating temperature	T _{OP}	-30	+85	°C	
Storage temperature	T _{ST}	-30	+85	°C	

8.1.2 DC Electrical Characteristics (Ta=25°C)

(Ambient temperature:25°C, VDD=2.8V, VDDIO=1.8V or VDDIO=VDD)

Item	Min.	Typ.	Max.	Unit	Note
Power Supply Voltage/VDD	2.66	3.3	3.47	V	
Normal mode operating current	--	8	14.5	mA	
Green mode operating current	--	3.3	--	mA	
Sleep mode operating current	70	--	120	uA	
Doze mode operating current	--	0.78	--	mA	
Digital Input low voltage/VIL	-0.3	--	0.25*VDD	V	
Digital Input high voltage/VIH	0.75*VDD	--	VDD+0.3	V	
Digital Output low voltage/VOL	--	--	0.15*VDD	V	
Digital Output high voltage/VOH	0.85*VDD	--	--	V	

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常备库存 Stock For Sale	长期供货 Long Time supply	支持小量 NO MOQ	品种齐全 In Full Range	

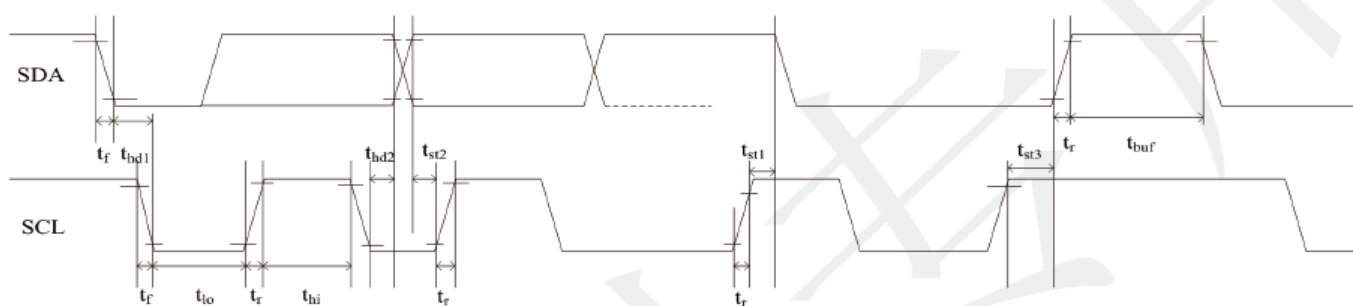
8.1.3 AC Characteristics

(Ambient temperature:25°C, VDD=2.8V, VDDIO=1.8V)

Parameter	Min	Typ	Max	Unit	Note
OSC oscillation frequency	59	60	61	MHZ	
I/O output rise time,low to high	-	14	-	ns	
I/O output rfall time,high to low	-	14	-	ns	

8.2 I2C Timing

GT911 provides a standard I2C interface for SCL and SDA to communicate with the host. GT911 always serves as slave device in the system with all communication being initialized by the host. It is strongly recommended that transmission rate be kept at or below 400Kbps. The I2C timing is shown below:



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Test condition 1: 1.8V host interface voltage, 400Kbps transmission rate, 2K pull-up resistor

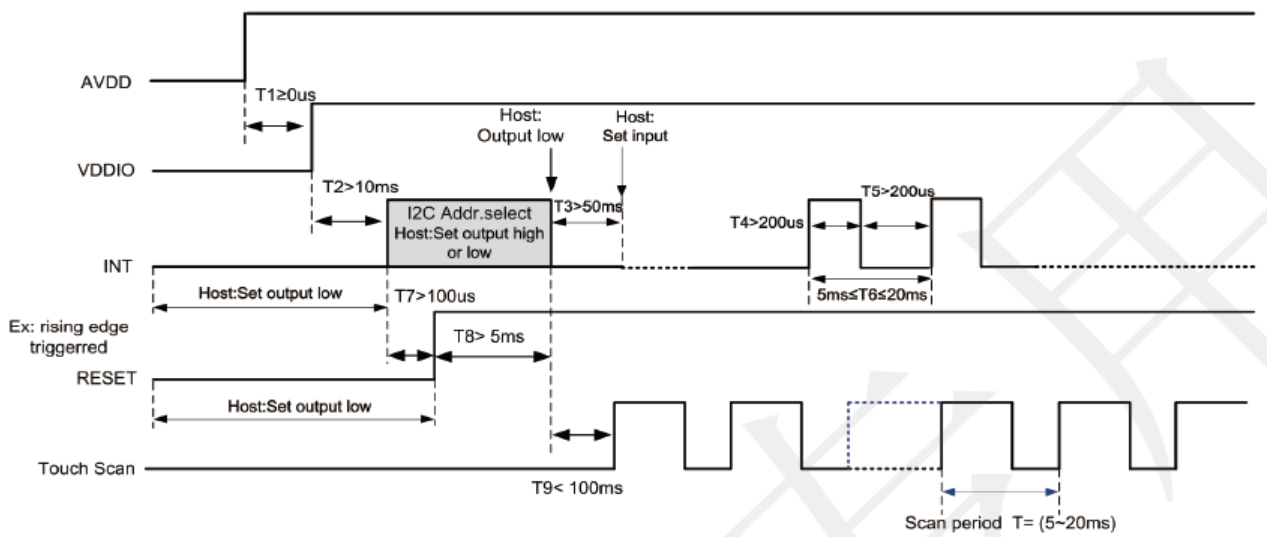
Parameter	Symbol	Min.	Max.	Unit
SCL low period	t_{lo}	1.3	-	us
SCL high period	t_{hi}	0.6	-	us
SCL setup time for Start condition	t_{st1}	0.6	-	us
SCL setup time for Stop condition	t_{st3}	0.6	-	us
SCL hold time for Start condition	t_{hd1}	0.6	-	us
SDA setup time	t_{st2}	0.1	-	us
SDA hold time	t_{hd2}	0	-	us

Test condition 2: 3.3V host interface voltage, 400Kbps transmission rate, 2K pull-up resistor

Parameter	Symbol	Min.	Max.	Unit
SCL low period	t_{lo}	1.3	-	us
SCL high period	t_{hi}	0.6	-	us
SCL setup time for Start condition	t_{st1}	0.6	-	us
SCL setup time for Stop condition	t_{st3}	0.6	-	us
SCL hold time for Start condition	t_{hd1}	0.6	-	us
SDA setup time	t_{st2}	0.1	-	us
SDA hold time	t_{hd2}	0	-	us

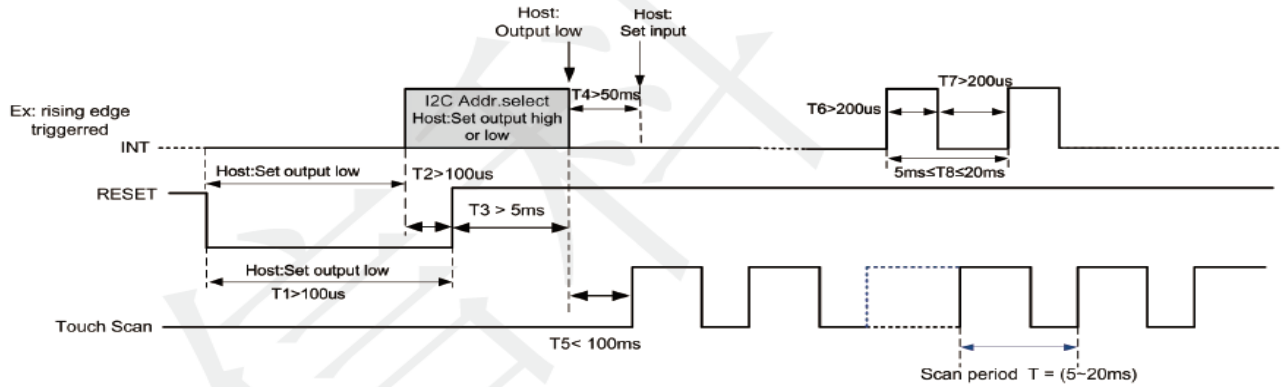
GT911 supports two I2C slave addresses: 0xBA/0xBB and 0x28/0x29. The host can select the address by changing the status of Reset and INT pins during the power-on initialization phase. See the diagram below for configuration methods and timings:

Power-on Timing:

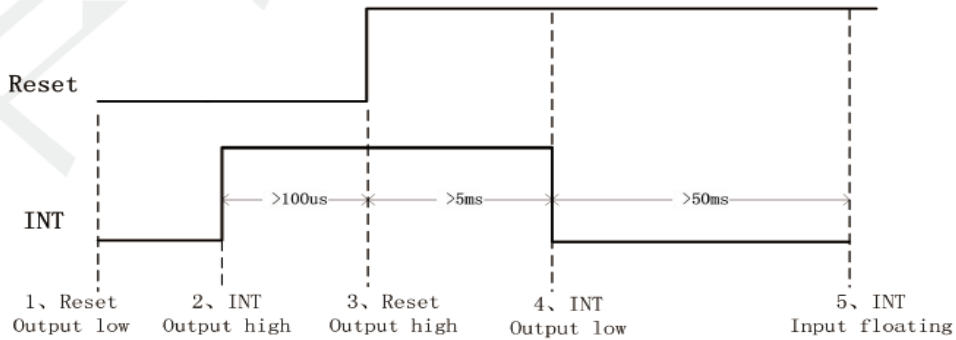


Part. No	KD035QHFID161-C062B	REV	V1.0	Page 24 of 38
常备库存 Stock For Sale	长期供货 Long Time supply	支持小量 NO MOQ	品种齐全 In Full Range	

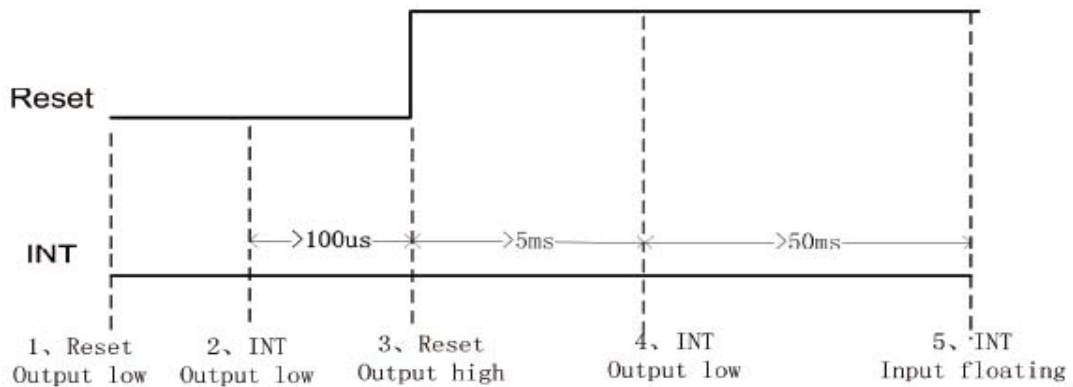
Timing for host resetting GT911:



Timing for setting slave address to 0x28/0x29:



Timing for setting slave address to 0xBA/0xBB:



Part. No	KD035QHFD161-C062B	REV	V1.0	Page 25 of 38
常备库存 Stock For Sale	长期供货 Long Time supply	支持小量 NO MOQ	品种齐全 In Full Range	

a) Data Transmission

(For example: device address is 0xBA/0xBB)

Communication is always initiated by the host. Valid Start condition is signaled by pulling SDA line from “high” to “low” when SCL line is “high”. Data flow or address is transmitted after the Start condition.

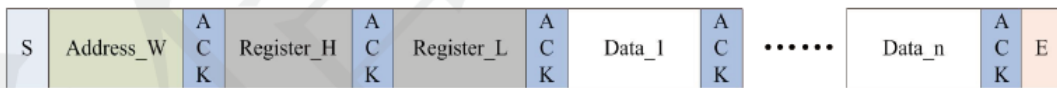
All slave devices connected to I²C bus should detect the 8-bit address issued after Start condition and send the correct ACK. After receiving matching address, GT911 acknowledges by configuring SDA line as output port and pulling SDA line low during the ninth SCL cycle. When receiving unmatched address, namely, not 0xBA or 0xBB, GT911 will stay in an idle state.

For data bytes on SDA, each of 9 serial bits will be sent on nine SCL cycles. Each data byte consists of 8 valid data bits and one ACK or NACK bit sent by the recipient. The data transmission is valid when SCL line is “high”.

When communication is completed, the host will issue the STOP condition. Stop condition implies the transition of SDA line from “low” to “high” when SCL line is “high”.

b) Writing Data to GT911

(For example: device address is 0xBA/0xBB)



Timing for Write Operation

The diagram above displays the timing sequence of the host writing data onto GT911. First, the host issues a Start condition. Then, the host sends 0xBA (address bits and R/W bit; R/W bit as 0 indicates Write operation) to the slave device.

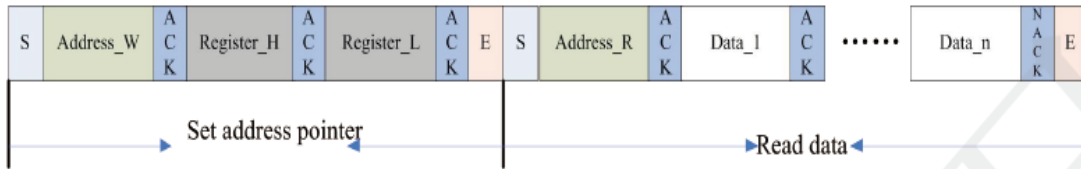
After receiving ACK, the host sends the 16-bit register address (where writing starts) and the 8-bit data bytes (to be written onto the register).

The location of the register address pointer will automatically add 1 after every Write Operation. Therefore, when the host needs to perform Write Operations on a group of registers of continuous addresses, it is able to write continuously. The Write Operation is terminated when the host issues the Stop condition.

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c) Reading Data from GT911

(For example: device address is 0xBA/0xBB)



Timing for Read Operation

The diagram above is the timing sequence of the host reading data from GT911. First, the host issues a Start condition and sends 0xBA (address bits and R/W bit; R/W bit as 0 indicates Write operation) to the slave device.

After receiving ACK, the host sends the 16-bit register address (where reading starts) to the slave device. Then the host sets register addresses which need to be read.

Also after receiving ACK, the host issues the Start condition once again and sends 0xBB (Read Operation). After receiving ACK, the host starts to read data.

GT911 also supports continuous Read Operation and, by default, reads data continuously. Whenever receiving a byte of data, the host sends an ACK signal indicating successful reception. After receiving the last byte of data, the host sends a NACK signal followed by a STOP condition which terminates communication.

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常备库存 Stock For Sale	长期供货 Long Time supply	支持小量 NO MOQ	品种齐全 In Full Range	

9. LCD Module Out-Going Quality Level

9.1 VISUAL & FUNCTION INSPECTION STANDARD

9.1.1 Inspection conditions

Inspection performed under the following conditions is recommended.

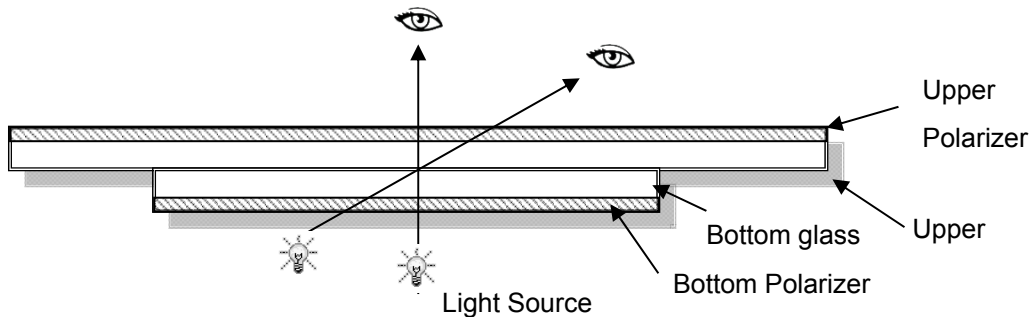
Temperature : $25\pm 5^{\circ}\text{C}$

Humidity : $65\%\pm 10\%\text{RH}$

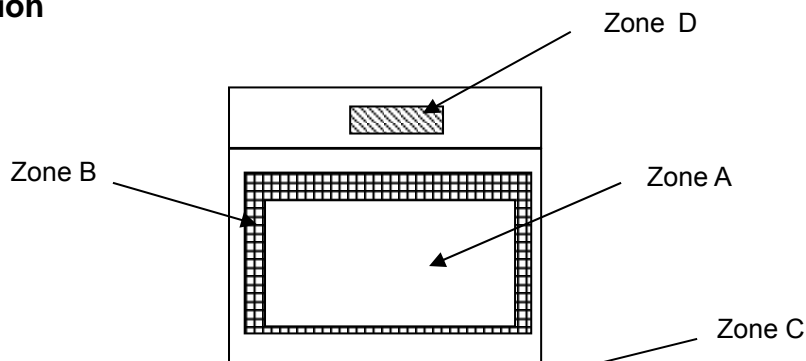
Viewing Angle : Normal viewing Angle.

Illumination: Single fluorescent lamp (300 to 700Lux)

Viewing distance:30-50cm



9.1.2 Definition



Zone A : Effective Viewing Area(Character or Digit can be seen)

Zone B : Viewing Area except Zone A

Zone C : Outside (Zone A+Zone B) which can not be seen after assembly by customer .)

Zone D : IC Bonding Area

Note:

As a general rule ,visual defects in Zone C can be ignored when it doesn't effect product function or appearance after assembly by customer

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9.1.3 Sampling Plan

According to GB/T 2828-2003 ; , normal inspection, Class II

AQL:

Major defect	Minor defect
0.65	1.5

LCD: Liquid Crystal Display , LCM: Liquid Crystal Module, CTP: Capacitive Touch Panel

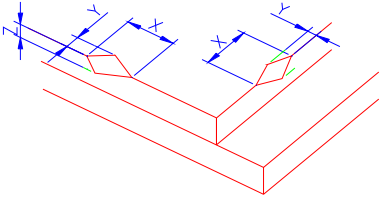
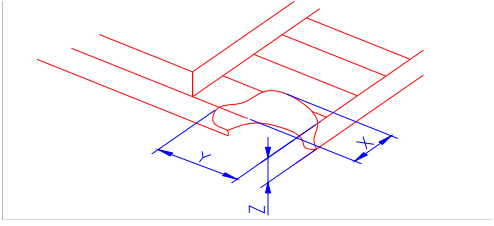
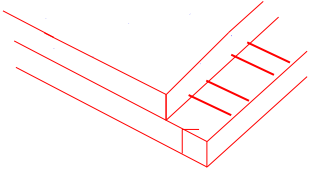
No	Items to be inspected	Criteria	Classification of defects
1	Functional defects	1) No display, Open or miss line 2) Display abnormally, Short 3) Backlight no lighting, abnormal lighting. etc	Major
2	Missing	Missing components and etc	
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed, deformation and etc	
4	Color tone	Color unevenness, refer to limited sample	Minor
5	Spot/Line defect	Light dot, Dim spot, (Note1) Polarizer Air Bubble, Polarizer accidented spot and etc.	
6	Soldering appearance	Good soldering , Peeling off is not allowed and etc.	
7	LCD/Polarizer/CTP	Black/White spot/line, scratch, crack, etc.	

Note1: a) Light dot: Dots appear bright and unchanged in size in which LCD panel is displaying under black pattern.

b) Dim dot: Dots appear dark and unchanged in size in which LCD panel is displaying under pure red, green, blue picture.



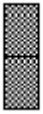
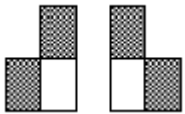
Part. No	KD035QHFID161-C062B	REV	V1.0	Page 29 of 38
	常备库存 Stock For Sale	长期供货 Long Time supply	支持小量 NO MOQ	品种齐全 In Full Range

9.1.4 Criteria (Visual)


Number	Items	Criteria(mm)						
1.0 LCD Crack/Broken NOTE: X: Length Y: Width Z: Height L: Length of ITO, T: Height of LCD	(1) The edge of LCD broken	 <table border="1" data-bbox="756 667 1455 815"> <thead> <tr> <th>X</th> <th>Y</th> <th>Z</th> </tr> </thead> <tbody> <tr> <td>≤3.0mm</td> <td><Inner border line of the seal</td> <td>≤T</td> </tr> </tbody> </table>	X	Y	Z	≤3.0mm	<Inner border line of the seal	≤T
X	Y	Z						
≤3.0mm	<Inner border line of the seal	≤T						
	(2)LCD corner broken	 <table border="1" data-bbox="813 1124 1394 1223"> <thead> <tr> <th>X</th> <th>Y</th> <th>Z</th> </tr> </thead> <tbody> <tr> <td>≤3.0mm</td> <td>≤L</td> <td>≤T</td> </tr> </tbody> </table>	X	Y	Z	≤3.0mm	≤L	≤T
X	Y	Z						
≤3.0mm	≤L	≤T						
	(3) LCD crack	 <p style="text-align: center;">Crack Not allowed</p>						



2.0	Spot defect	① light dot (black/white spot , pinhole, stain, etc.)			
	<p style="text-align: center;">$\Phi=(X+Y)/2$</p>	Zone	Acceptable Qty		
		Size (mm)	A	B	C
		$\Phi \leq 0.15$	Ignore		
		$0.15 < \Phi \leq 0.25$	3(distance ≥ 10 mm)		
	$0.25 < \Phi \leq 0.4$	2(distance ≥ 10 mm)			
	$\Phi > 0.4$	0			
		② Dim spot (light leakage、dent、dark spot, etc)			
		Zone	Acceptable Qty		
		Size (mm)	A	B	C
		$\Phi \leq 0.15$	Ignore		
		$0.15 < \Phi \leq 0.25$	3(distance ≥ 10 mm)		
		$0.25 < \Phi \leq 0.4$	2(distance ≥ 10 mm)		
		$\Phi > 0.4$	0		
		③ Polarizer accidented spot			
		Zone	Acceptable Qty		
		Size (mm)	A	B	C
		$\Phi \leq 0.2$	Ignore		
		$0.2 < \Phi \leq 0.5$	2(distance ≥ 10 mm)		
		$\Phi > 0.5$	0		
		④ Polarizer Bubble			
		Zone	Acceptable Qty		
		Size (mm)	A	B	C
		$\Phi \leq 0.2$	Ignore		
		$0.2 < \Phi \leq 0.4$	3(distance ≥ 10 mm)		
		$\Phi > 0.4$	0		

3.0	LCD Pixel defect	<p>Pixel bad points</p> <table border="1"> <thead> <tr> <th data-bbox="539 309 730 360">Item</th> <th data-bbox="730 309 1241 360">Zone A</th> <th data-bbox="1241 309 1497 360">Acceptable Qty</th> </tr> </thead> <tbody> <tr> <td data-bbox="539 360 730 521" rowspan="3">Bright dot</td> <td data-bbox="730 360 1241 416">Random</td> <td data-bbox="1241 360 1497 416">N≤2</td> </tr> <tr> <td data-bbox="730 416 1241 472">2 dots adjacent</td> <td data-bbox="1241 416 1497 472">N≤0</td> </tr> <tr> <td data-bbox="730 472 1241 521">3 dots adjacent</td> <td data-bbox="1241 472 1497 521">N≤0</td> </tr> <tr> <td data-bbox="539 521 730 689" rowspan="3">Dark dot</td> <td data-bbox="730 521 1241 577">Random</td> <td data-bbox="1241 521 1497 577">N≤2</td> </tr> <tr> <td data-bbox="730 577 1241 633">2 dots adjacent</td> <td data-bbox="1241 577 1497 633">N≤0</td> </tr> <tr> <td data-bbox="730 633 1241 689">3 dots adjacent</td> <td data-bbox="1241 633 1497 689">N≤0</td> </tr> <tr> <td data-bbox="539 689 730 1003">Distance</td> <td data-bbox="730 689 1241 1003"> 1. Minimum Distance Between Bright dots. 2. Minimum Distance Between dark dots 3. Minimum Distance Between dark and bright dot. </td> <td data-bbox="1241 689 1497 1003">5mm</td> </tr> <tr> <td colspan="2" data-bbox="539 1003 1241 1059">Total bright and dark dot</td> <td data-bbox="1241 1003 1497 1059">N≤4</td> </tr> </tbody> </table> <p>Note:</p> <p>A) Bright dot: Dots appear bright and unchanged in size in which LCD panel is displaying under black pattern.</p> <p>B) Dark dot: Dots appear dark and unchanged in size in which LCD panel is displaying under pure red, green, blue picture.</p> <p>C) 2 dot adjacent = 1 pair = 2 dots</p> <p>Picture:</p> <div style="display: flex; justify-content: space-around; align-items: flex-start;"> <div style="text-align: center;">  <p>2 dot adjacent</p> </div> <div style="text-align: center;">  <p>2 dot adjacent</p> </div> </div> <div style="display: flex; justify-content: space-around; align-items: flex-start; margin-top: 20px;"> <div style="text-align: center;">  <p>2 dot adjacent (vertical)</p> </div> <div style="text-align: center;">  <p>2 dot adjacent (slant)</p> </div> </div>	Item	Zone A	Acceptable Qty	Bright dot	Random	N≤2	2 dots adjacent	N≤0	3 dots adjacent	N≤0	Dark dot	Random	N≤2	2 dots adjacent	N≤0	3 dots adjacent	N≤0	Distance	1. Minimum Distance Between Bright dots. 2. Minimum Distance Between dark dots 3. Minimum Distance Between dark and bright dot.	5mm	Total bright and dark dot		N≤4
Item	Zone A	Acceptable Qty																							
Bright dot	Random	N≤2																							
	2 dots adjacent	N≤0																							
	3 dots adjacent	N≤0																							
Dark dot	Random	N≤2																							
	2 dots adjacent	N≤0																							
	3 dots adjacent	N≤0																							
Distance	1. Minimum Distance Between Bright dots. 2. Minimum Distance Between dark dots 3. Minimum Distance Between dark and bright dot.	5mm																							
Total bright and dark dot		N≤4																							

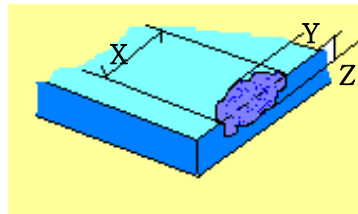


4.0	Line defect (LCD /Polarizer backlight black/white line, scratch, stain)  W: width, L : length N : Count	<table border="1"> <thead> <tr> <th rowspan="2">Width(mm)</th> <th rowspan="2">Length(m)</th> <th colspan="3">Acceptable Qty</th> </tr> <tr> <th>A</th> <th>B</th> <th>C</th> </tr> </thead> <tbody> <tr> <td>$\Phi \leq 0.05$</td> <td>Ignore</td> <td colspan="2">Ignore</td> <td rowspan="3">Ignore</td> </tr> <tr> <td>$0.05 < W \leq 0.06$</td> <td>$L \leq 4.0$</td> <td colspan="2">$N \leq 3$</td> </tr> <tr> <td>$0.06 < W \leq 0.08$</td> <td>$L \leq 3.0$</td> <td colspan="2">$N \leq 2$</td> </tr> <tr> <td>$W > 0.08$</td> <td colspan="4">Define as spot defect</td> </tr> </tbody> </table>	Width(mm)	Length(m)	Acceptable Qty			A	B	C	$\Phi \leq 0.05$	Ignore	Ignore		Ignore	$0.05 < W \leq 0.06$	$L \leq 4.0$	$N \leq 3$		$0.06 < W \leq 0.08$	$L \leq 3.0$	$N \leq 2$		$W > 0.08$	Define as spot defect			
		Width(mm)			Length(m)	Acceptable Qty																						
			A	B		C																						
		$\Phi \leq 0.05$	Ignore	Ignore		Ignore																						
		$0.05 < W \leq 0.06$	$L \leq 4.0$	$N \leq 3$																								
$0.06 < W \leq 0.08$	$L \leq 3.0$	$N \leq 2$																										
$W > 0.08$	Define as spot defect																											
5.0	Electronic Components SMT.	Not allow missing parts, solderless connection, cold solder joint, mismatch. The positive and negative polarity opposite																										
6.0	Display color & Brightness.	1. Color: Measuring the color coordinates, The measurement standard according to the datasheet or samples. 2. Brightness: Measuring the brightness of White screen, The measurement standard according to the datasheet or Samples.																										
7.0	LCD Mura/Waving/ Hot spot	Not visible through 5% ND filter in 50% gray or judge by limit sample if necessary.																										

8.0	CTP Related	CTP Cover sensor accidented black/white spot	<table border="1"> <thead> <tr> <th rowspan="2">Size Φ(mm)</th> <th colspan="3">Acceptable Qty</th> </tr> <tr> <th>A</th> <th>B</th> <th>C</th> </tr> </thead> <tbody> <tr> <td>$\Phi \leq 0.1$</td> <td colspan="2">Ignore</td> <td rowspan="4">Ignore</td> </tr> <tr> <td>$0.1 < \Phi \leq 0.2$</td> <td colspan="2">3 (distance ≥ 10mm)</td> </tr> <tr> <td>$0.20 < \Phi \leq 0.25$</td> <td colspan="2">2 (distance ≥ 10mm)</td> </tr> <tr> <td>$\Phi > 0.25$</td> <td colspan="2">0</td> </tr> </tbody> </table>	Size Φ (mm)	Acceptable Qty			A	B	C	$\Phi \leq 0.1$	Ignore		Ignore	$0.1 < \Phi \leq 0.2$	3 (distance ≥ 10 mm)		$0.20 < \Phi \leq 0.25$	2 (distance ≥ 10 mm)		$\Phi > 0.25$	0	
			Size Φ (mm)		Acceptable Qty																		
				A	B	C																	
			$\Phi \leq 0.1$	Ignore		Ignore																	
			$0.1 < \Phi \leq 0.2$	3 (distance ≥ 10 mm)																			
$0.20 < \Phi \leq 0.25$	2 (distance ≥ 10 mm)																						
$\Phi > 0.25$	0																						



		CTP Cover scratch	<table border="1"> <tr> <th rowspan="2">Width(mm)</th> <th rowspan="2">Ignore(mm)</th> <th colspan="3">Acceptable Qty</th> </tr> <tr> <th>A</th> <th>B</th> <th>C</th> </tr> <tr> <td>$\Phi \leq 0.05$</td> <td>Ignore</td> <td colspan="3">Ignore</td> </tr> <tr> <td>$0.05 < W \leq 0.06$</td> <td>$L \leq 4.0$</td> <td colspan="3">$N \leq 3$</td> </tr> <tr> <td>$0.06 < W \leq 0.08$</td> <td>$L \leq 3.0$</td> <td colspan="3">$N \leq 2$</td> </tr> <tr> <td>$0.08 < W$</td> <td colspan="4">Define as spot defect</td> </tr> </table>			Width(mm)	Ignore(mm)	Acceptable Qty			A	B	C	$\Phi \leq 0.05$	Ignore	Ignore			$0.05 < W \leq 0.06$	$L \leq 4.0$	$N \leq 3$			$0.06 < W \leq 0.08$	$L \leq 3.0$	$N \leq 2$			$0.08 < W$	Define as spot defect			
			Width(mm)	Ignore(mm)	Acceptable Qty																												
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$0.06 < W \leq 0.08$	$L \leq 3.0$	$N \leq 2$																															
$0.08 < W$	Define as spot defect																																
CTP Cover Pinhole/ Lack of ink	<table border="1"> <tr> <th rowspan="2">Zone Size (mm)</th> <th>Acceptable Qty</th> </tr> <tr> <td>C</td> </tr> <tr> <td>$\Phi \leq 0.1$</td> <td>Ignore</td> </tr> <tr> <td>$0.1 < \Phi \leq 0.25$</td> <td>3(distance ≥ 10mm)</td> </tr> <tr> <td>$0.25 < \Phi \leq 0.3$</td> <td>2(distance ≥ 10mm)</td> </tr> <tr> <td>$\Phi > 0.3$</td> <td>0</td> </tr> </table>		Zone Size (mm)	Acceptable Qty	C	$\Phi \leq 0.1$	Ignore	$0.1 < \Phi \leq 0.25$	3(distance ≥ 10 mm)	$0.25 < \Phi \leq 0.3$	2(distance ≥ 10 mm)	$\Phi > 0.3$	0																				
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CTP Bonding bubble/ accidented spot	<table border="1"> <tr> <th rowspan="2">Size Φ(mm)</th> <th colspan="2">Acceptable Qty</th> </tr> <tr> <th>A</th> <th>B</th> </tr> <tr> <td>$\Phi \leq 0.1$</td> <td colspan="2">Ignore</td> </tr> <tr> <td>$0.1 < \Phi \leq 0.2$</td> <td colspan="2">3(distance ≥ 10mm)</td> </tr> <tr> <td>$0.2 < \Phi \leq 0.25$</td> <td colspan="2">2(distance ≥ 10mm)</td> </tr> <tr> <td>$\Phi > 0.25$</td> <td colspan="2">0</td> </tr> </table>			Size Φ (mm)	Acceptable Qty		A	B	$\Phi \leq 0.1$	Ignore		$0.1 < \Phi \leq 0.2$	3(distance ≥ 10 mm)		$0.2 < \Phi \leq 0.25$	2(distance ≥ 10 mm)		$\Phi > 0.25$	0														
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Assembly deflection	beyond the edge of backlight ≤ 0.2 mm																																
CTP cover broken X : length Y : width Z : height	<table border="1"> <tr> <th>X</th> <th>Y</th> <th>Z</th> </tr> <tr> <td>$X \leq 0.5$mm</td> <td>$Y \leq 0.5$mm</td> <td>$Z < \text{cover thickness}$ s</td> </tr> </table>		X	Y	Z	$X \leq 0.5$ mm	$Y \leq 0.5$ mm	$Z < \text{cover thickness}$ s																									
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Circuitry broken is not allowed.																																	

		CTP cover broken X : length Y : width Z : height	X	Y	Z	
			$X \leq 0.3\text{mm}$	$Y \leq 0.3\text{mm}$	$Z < \text{cover thickness}$	
* Circuitry broken is not allowed.						

Criteria (functional items)

Number	Items	Criteria (mm)
1	No display	Not allowed
2	Missing segment	Not allowed
3	Short	Not allowed
4	Backlight no lighting	Not allowed
5	CTP no function	Not allowed

10. Reliability Test Result

Item	Condition	Inspection after test
High Temperature Operating	85°C,96H	Inspection after 2~4hours storage at room temperature, the sample shall be free from defects: 1.Air bubble in the LCD; 2.Non-display; 3.Missing segments/line; 4.Glass crack; 5.Current IDD is twice higher than initial value.
Low Temperature Operating	-30°C, 96HR	
High Temperature Storage	85°C, 96HR	
Low Temperature Storage	-30°C, 96HR	
High Temperature & High Humidity Operating	+60°C, 90% RH ,96 hours.	
Thermal Shock (Non-operation)	-30°C,30 min ↔ +80°C,30 min, Change time:5min 20CYC.	
ESD test	C=150pF, R=330,5points/panel Air:±8KV, 5times; Contact:±6KV, 5 times; (Environment: 15°C~35°C, 30%~60%).	
Vibration (Non-operation)	Frequency range:10~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z. (6 hours for total) (Package condition).	
Box Drop Test	1 Corner 3 Edges 6 faces,80cm(MEDIUM BOX)	

Remark:

- 1.The test samples should be applied to only one test item.
- 2.Sample size for each test item is 5~10pcs.
- 3.For Damp Proof Test, Pure water(Resistance > 10MΩ) should be used.
- 4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.
- 5.Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

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11. Cautions and Handling Precautions

11.1 Handling and Operating the Module

- (1) When the module is assembled, it should be attached to the system firmly.
Do not warp or twist the module during assembly work.
- (2) Protect the module from physical shock or any force. In addition to damage, this may cause improper operation or damage to the module and back-light unit.
- (3) Note that polarizer is very fragile and could be easily damaged. Do not press or scratch the surface.
- (4) Do not allow drops of water or chemicals to remain on the display surface.
If you have the droplets for a long time, staining and discoloration may occur.
- (5) If the surface of the polarizer is dirty, clean it using some absorbent cotton or soft cloth.
- (6) The desirable cleaners are water, IPA (Isopropyl Alcohol) or Hexane.
Do not use ketene type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanent damage to the polarizer due to chemical reaction.
- (7) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, legs, or clothes, it must be washed away thoroughly with soap.
- (8) Protect the module from static; it may cause damage to the CMOS ICs.
- (9) Use finger-stalls with soft gloves in order to keep display clean during the incoming inspection and assembly process.
- (10) Do not disassemble the module.
- (11) Protection film for polarizer on the module shall be slowly peeled off just before use so that the electrostatic charge can be minimized.
- (12) Pins of I/F connector shall not be touched directly with bare hands.
- (13) Do not connect, disconnect the module in the "Power ON" condition.
- (14) Power supply should always be turned on/off by the item 6.1 Power On Sequence & 6.2 Power Off Sequence

11.2 Storage and Transportation.

- (1) Do not leave the panel in high temperature, and high humidity for a long time.
It is highly recommended to store the module with temperature from 0 to 35 °C and relative humidity of less than 70%
- (2) Do not store the TFT-LCD module in direct sunlight.
- (3) The module shall be stored in a dark place. When storing the modules for a long time, be sure to adopt effective measures for protecting the modules from strong ultraviolet radiation, sunlight, or fluorescent light.
- (4) It is recommended that the modules should be stored under a condition where no condensation is allowed. Formation of dewdrops may cause an abnormal operation or a failure of the module.
In particular, the greatest possible care should be taken to prevent any module from being operated where condensation has occurred inside.
- (5) This panel has its circuitry FPC on the bottom side and should be handled carefully in order not to be stressed.

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12. Packing

----TBD-----

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